

WEST Search History for Application 10540729

Creation Date: 2010012821:43

205/239-242.ccls.PGPB, USPT, USOC OR YES 12-21-2008
205/239-242.ccls.PGPB, USPT, USOC OR YES 12-21-2008
(205/239-242.ccls.) and (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)PGPB, USPT, USOC OR YES 12-21-2008
surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)PGPB, USPT, USOC OR YES 12-21-2008
(surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)) and (thin near5 film)PGPB, USPT, USOC OR YES 12-21-2008
(surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic) and (thin near5 film)) and (electroplat\$4 or plat\$4 or electrodeposit\$4)PGPB, USPT, USOC OR YES 12-21-2008
(thin near5 film) same (electroplat\$4 or plat\$4 or electrodeposit\$4)PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or plat\$4 or electrodeposit\$4)) and (surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic))PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or plat\$4 or electrodeposit\$4) and surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)) and (copper same(ga or gallium or al or aluminum))PGPB, USPT, USOC OR YES 12-21-2008
(thin near5 film) same (electroplat\$4 or electrodeposit\$4)PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or electrodeposit\$4)) and ((thin near5 film) same (electroplat\$4 or plat\$4 or electrodeposit\$4) and surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic) and (copper same(ga or gallium or al or aluminum)))PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or electrodeposit\$4)) and (copper same (ga or gallium or al or aluminum))PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or electrodeposit\$4) and (copper same (ga or gallium or al or aluminum))) and (surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic))PGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or electrodeposit\$4) and (copper same (ga or gallium or al or aluminum)) and surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)) not ((thin near5 film) same (electroplat\$4 or electrodeposit\$4) and (thin near5 film) same (electroplat\$4 or plat\$4 or electrodeposit\$4) and surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic) and (copper same(ga or gallium or al or aluminum)))PGPB, USPT, USOC OR YES 12-21-2008
(electroplat\$4 or electrodeposit\$4)PGPB, USPT, USOC OR YES 12-21-2008
((electroplat\$4 or electrodeposit\$4)) and dodecylsulfatePGPB, USPT, USOC OR YES 12-21-2008
((thin near5 film) same (electroplat\$4 or electrodeposit\$4) and (copper same (ga or gallium or al or aluminum))) and ((electroplat\$4 or electrodeposit\$4) and dodecylsulfate)PGPB, USPT, USOC OR YES 12-21-2008
(copper same (ga or gallium or al or aluminum)) and ((electroplat\$4 or electrodeposit\$4) and dodecylsulfate)PGPB, USPT, USOC OR YES 12-21-2008
((copper same (ga or gallium or al or aluminum)) and (electroplat\$4 or electrodeposit\$4) and

dodecylsulfate) not ((thin near5 film) same (electroplat\$4 or electrodeposit\$4) and (copper same (ga or gallium or al or aluminum)) and (electroplat\$4 or electrodeposit\$4) and dodecylsulfate)PGPB, USPT, USOC OR YES 12-21-2008
(copper same (ga or gallium or al or aluminum))EPAB, JPAB, DWPI, TDBD OR YES 12-21-2008
surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)EPAB, JPAB, DWPI, TDBD OR YES 12-21-2008
(surfactant same (dodecylsulfate or (butyne near3 diol) or maleic or succinic or fumaric or crotonic)) and ((copper same (ga or gallium or al or aluminum)))EPAB, JPAB, DWPI, TDBD OR YES 12-21-2008